SL1002A Series



Agency Approvals

AGENCY	AGENCY FILE NUMBER
FL	E128662

2 Electrode GDT Graphical Symbol



Additional Information



Datasheet





Samples

Description

The Broadband Optimized[™] SL1002A series has been especially developed for use in broadband equipment. Special design features provide high levels of protection against fast rising transients in the 100V/µs to 1kV/µs range usually caused by lightning disturbances. These devices have ultra low capacitance (typically 1.2pF or less) and present insignificant signal losses up to 1.5GHz. These devices are extremely robust and are able to divert a 5000A pulse without destruction. For AC Power Cross of long duration, overcurrent protection is recommended.

Features

- RoHS compliant/Leadfree
- Ultra low insertion loss
- Surface mountable
- 5kA surge capability tested with 8/20µS– Pulse as defined by IEC 61000-4-5
- Excellent response to fast rising transients
- Can be used to meet Telcordia GR1089 without series resistance

Applications

- Broadband equipment
- ADSL equipment
- XDSL equipment

 10/700 6kV capability, as per ITU-T Rec. K.21, enhanced test level

RoHS

(Pi) **4**1

- 2000 A 2/10µs surge rating
- Meet FCC part 68 10/160µs waveform, 200A test and 10/560µs waveform 100A test
- Halogen-free

- Satellite and CATV equipment
- General telecom equipment

Gas Discharge Tubes SL1002A Series



Electrical Characteristics Device Specifications (at 25°C) Life Ratings DC Breakdown Impulse Impulse Insulation Capaci Arc Surge Nominal Nominal Max Impulse Discharge Breakdown Breakdown Resistance in Volts1,2 Voltage Impulse Holdover Current Part Number Discharge Discharge in Volts^{3,4} in Volts^{3,4} Voltage⁵ Current Current 10/1000us (10x1s @50-60Hz) MAX MIN TYP MAX MAX MIN TYP TYP @ 10/350 µs SL1002A075 60 75 90 10⁹ Ω 400 650 50 V SL1002A090 72 90 (at 50V) 108 SL1002A230 184 230 276 SL1002A250 200 250 300 600 700 SL1002A260 210 260 310 300 10 shots7 10⁹ Ω 1.2 pF ~15 V 5 A 2 kA 1.5 kA shots6 (@ 5kA) (at 100V) SL1002A350 280 350 420 800 900 135 V SL1002A470 376 470 564 900 1000 SL1002A600 480 600 720 1100 1200 10⁹ Ω SL1002A600SP 570 600 780 1200 1300 (at 500V)

Notes:

1. At delivery AQL 0.65 level II, DIN ISO 2859

2. In ionized mode

3. In ionized mode, tested according to ITU-T Rec. K.12

4. Comparable to the silicon measurement Switching Voltage (Vs)

5. Reference REA PE-80, 0.2A. Tested to ITU-T Rec. K.12 and REA PE-80 < 150 msecs.

6. 300 Applications [150(+) & 150(-)]

7. 10x[5x (+) & 5x (-)] Applications

Product Characteristics

Materials	Construction = Ceramic Insulator Device Finish = Dull Tin-plated 17.5 +/-12.5 microns
Product Marking	Littelfuse 'LF' Mark, voltage and date code

Glow to Arc Transition Current	< 0.5 Amps	
Glow Voltage	~60 - 140 Volts	
Storage and Operational Temperature	-40 to +90°C	

Voltage vs. Time Characteristics





Insertion Loss Characteristics

Typical Insertion Loss Characteristics (90V)



Typical Insertion Loss Characteristics (600V)



Device Dimensions

'C' Type Core Devices





Dimensions are in millimeters [and inches]









Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Condition		Pb-free assembly
Pre Heat	-Temperature Min (T _{s(min)})	150°C
	-Temperature Max (T _{s(max)})	200°C
	-Time (Min to Max) (t _s)	60 – 180 seconds
Average Ramp-up Rate (Liquidus Temp (T_L) to peak)		3°C/second max.
T _{S(max)} to T _L - Ramp-up Rate		5°C/second max.
Reflow	-Temperature (T_L) (Liquidus)	217°C
	-Temperature (t _L)	60 – 150 seconds
PeakTemperature (T _P)		260 ^{+0/-5} °C
Time within 5°C of Actual Peak Temperature (t _p)		10 – 30 seconds
Ramp-down Rate		6°C/second max.
Time 25°C to Peak Temperature (T _P)		8 minutes max.
Do not exceed		260°C



Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation			
Preheat:				
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)			
Temperature Minimum:	100° C			
Temperature Maximum:	150° C			
Preheat Time:	60-180 seconds			
Solder Pot Temperature:	280° C Maximum			
Solder Dwell Time:	2-5 seconds			

Soldering Parameters - Hand Soldering

Solder Iron Temperature: 350° C +/- 5°C Heating Time: 5 seconds max.



Packaging

'C' Type Core Items: Package bulk pack in polybag, 1000 pcs/bag

'SM' Type Surface Mount Items: Packaged tape and reel carrier, 1000 pcs/reel (specifications below)



Part Numbering System and Ordering Information

SL1002 A XXX XX
Surge Capability

Voltage -

Pin Configuration –

C = Core (Packed in polybag, 1000pcs/bag)

SM = Surface Mount (Packed in carrier and tape, 1000pcs/reel)

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